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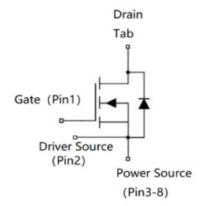
N-Channel 650 V (D-S) SiC MOSFET

Description

Silicon Carbide (SiC) MOSFET use a completely new technology that provide superior switching performance and higher reliability compared to Silicon. In addition, the low ON resistance and compact chip size ensure low capacitance and gate charge. Consequently, system benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size.

TOLL Pin Configuration





N-Channel SiC MOSFET

Ordering Information

FEATURES

- High Speed Switching with Low Capacitances
- Easy to parallel and simple to drive
- High Blocking Voltage with Low RDS(on)
- ROHS Compliant, Halogen free

APPLICATIONS

- EV Charging
- DC/DC Converters
- Switch Mode Power Supplies
- Power Factor Correction Modules
- Solar PV inverters

Part Number	Marking	Package	Packaging		
DTT150N65SC	DTT150N65SC	ToLL	Reel		



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Symbol	Parameter		Unit
V _{DS}	Drain-Source Voltage	650	V
۱ _D	Drain Current(continuous)at Tc=25 °C	150	А
ID	Drain Current(continuous)at Tc=100℃	100	А
I _{DM}	Drain Current (pulsed)	300	А
V _{GS}	Gate-Source Voltage	-10/+22	V
PD	Power Dissipation $T_c = 25^{\circ}C$	428	W
T _{J,} Tstg	Junction and Storage Temperature Range	-55 to +175	°C

Absolute Maximum Ratings(Tc=25°C)

Electrical Characteristics(T) = 25° C unless otherwise specified)

Typical Performance-Static

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
BV _{DS}	Drain-source Breakdown Voltage	I _D =250uA,V _{GS} =0V	650			V
	Zero Gate Voltage Drain Current	V _{DS} =650V,			100	μA
I _{DSS}	Zero Gale Voltage Drain Current	V _{GS} =0V, T _J =25°C			100	μA
1	Gate-body Leakage Current	V_{DS} =0V ; V_{GS} =-10 to			250	nA
I _{GSS}	Gale-body Leakage Current	20V			230	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D =22mA	2	3	4	V
VGSon	Recommended turn-on Voltage	Static		18		V
VGSoff	Recommended turn-off Voltage	Static		-5		V
	Static Drain-source On Resistance	V _{GS} =18V, I _D =75A		12	20	mΩ
R _{DS(on)}		V _{GS} =18V, I _D =75A		16		
		TJ=175℃				mΩ

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Typical Performance-Dynamic

Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit
C _{iss}	Input Capacitance			7160		pF
Coss	Output Capacitance	V_{DS} =400V,f=1MH _Z ,		325		pF
C _{rss}	Reverse Transfer Capacitance	– V _{AC} =25mV		31		pF
g _{fs}	Transconductance	V _{DS} =20V , I _D =15A		42		S
Eoss	C _{OSS} Stored Energy	V _{DS} =400V,f=1MH _Z		32		μJ
E _{ON}	Turn-On Energy (Body Diode)	V _{DS} =400V,V _{GS} =-5/20V, I _D =50A, L=60uH		426		μJ
EOFF	Turn-Off Energy (Body Diode)	TJ=175℃		282		μJ
Qg	Total Gate Charge V _{DS} =400V, V _{GS} =-5V/20V,			236		nC
Q_gs	Gate-source Charge	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = -3 \text{ V}/20 \text{ V},$ $I_{D} = 50 \text{ A}$		56		nC
Q_{gd}	Gate-Drain Charge			64		nC
R_{G} (int)	Internal Gate Resistance	f=1MHz,V _{AC} =25mV		2.2		Ω
t _{d(on)}	Turn-on Delay Time	Turn-on Delay Time V _{DS} =400V,V _{GS} =-5V/20V,		25		ns
tr	Rise Time	I _D =50A, L=60 μ H		34		ns
t _{d(off)}	Turn-off Delay Time	Rext=5Ω		62		ns
t _f	Fall Time			16		ns

Typical Performance-Reverse Diode(T_J = 25° C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
		V _{GS} =0V,I _F =50A,T _J =25°C		3.5	6	V
V _{FSD}	Forward Voltage	V _{GS} =0V,I _F =50A,T _J =175°C		3.0	6	V
ls	Continuous Diode Forward Current	V_{GS} =0V, T_C =25°C		80		А
t _{rr}	Reverse Recovery Time	V _{GS} =-5 V, I _F =50 A,		88		nS
Qrr	Reverse Recovery Charge V_R =400 V, TJ=175°C			680		nC
Irrm	Peak Reverse Recovery Current	d <i>i</i> /d <i>t</i> = 2400 A/µs		17		А

Thermal Characteristics

Symbol	Parameter	Value.	Unit	
Rejc	Thermal Resistance, Junction-to-Case	0.35	°C/W	
R _{0JA}	Thermal Resistance, Junction-to-Ambient	40	°C/W	

The values are based on the junction-to case thermal impedance which is measured with the device mounted to a large heat sink assuming maximum junction temperature of $Tj(max)=175^{\circ}$

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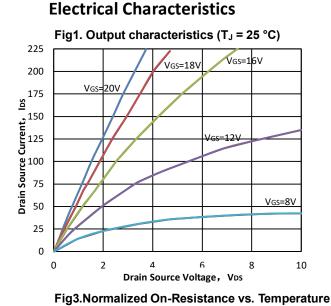


Fig2. Output characteristics (T_J = 175 °C)

VGs=20

VGs=18V

Vgs=12V

8

10

Vgs=16V

225

200

a 175

25

0

0



2

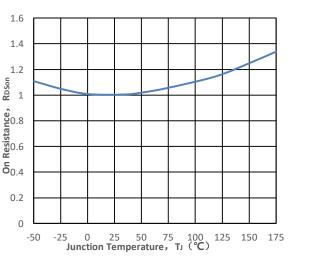
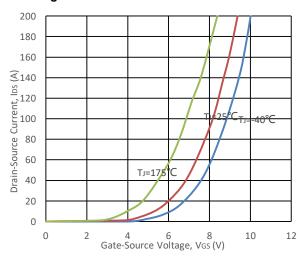
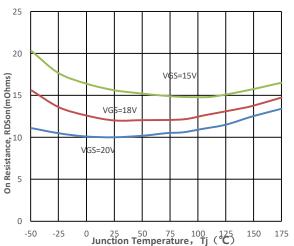


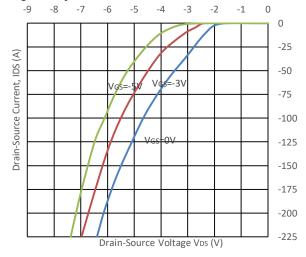
Fig5. Transfer Characteristic





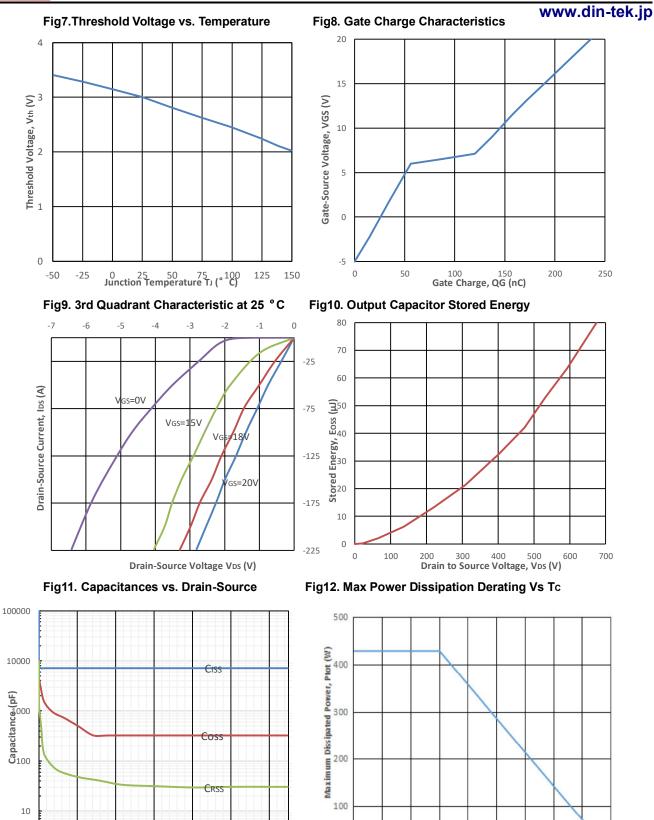
4 6 Drain Source Voltage, VDS

Fig6. Body Diode Characteristic at 25 °C



²⁰⁰ **Drain-Source Voltage**, **V**DS (V)

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-50

-25

50 75 100 Case Temperature, TC (°C)



100

0

0

25

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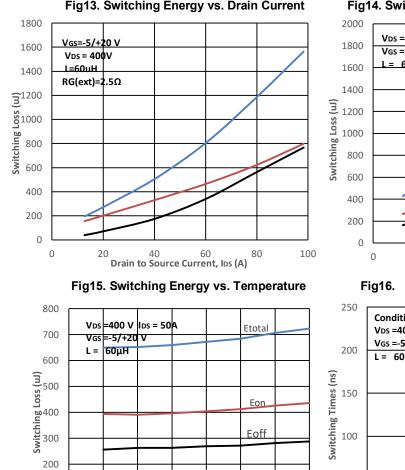
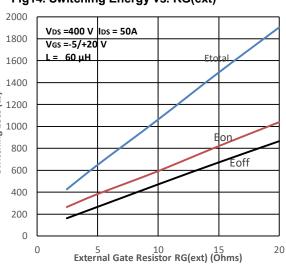
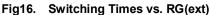
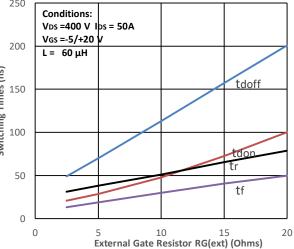


Fig13. Switching Energy vs. Drain Current

Fig14. Switching Energy vs. RG(ext)









50 Junction Temperature, TJ (°C)

150

175

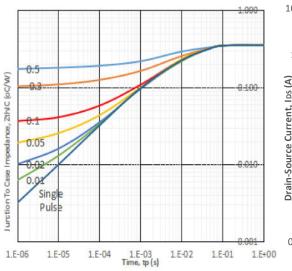
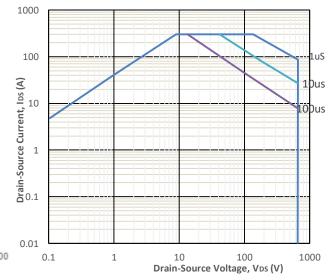


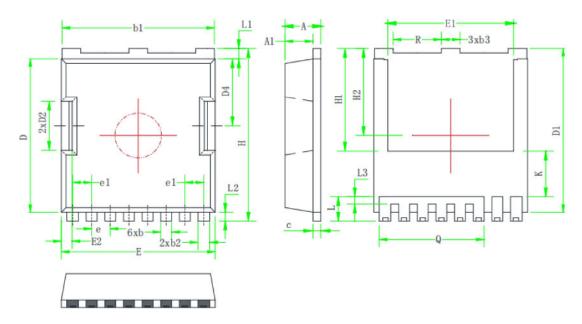
Fig18. Safe Operating Area





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(UNIT: mm) Dimensions

Symbol	Min	Тур	Max		Symbol	Min	Тур	Max
А	2.25	2.30	2.35		Е	9.85	9.90	9.95
A1	1.75	1.80	1.85		E1	8.00	8.10	8.20
b	0.65	0.70	0.75		E2	0.65	0.70	0.75
b1	9.75	9.80	9.90	1	Н	11.60	11.70	11.80
b2	0.70	0.75	0.80		H1	6.95 BSC		
b3	1.15	1.20	1.25	1	H2	5.90 BSC		
с	0.45	0.50	0.55	1	K	3.10 REF		
D	10.35	10.40	10.45		L	1.55	1.65	1.75
D1	11.00	11.10	11.20		L1	0.65	0.70	0.75
D2	3.25	3.30	3.35	1	L2	0.50	0.60	0.70
D4	4.50	4.55	4.60	1	L3	0.40	0.50	0.60
e	1.20 BSC				Q		6.75 REF	
e1	1.225 BSC				R	3.00	3.10	3.20

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